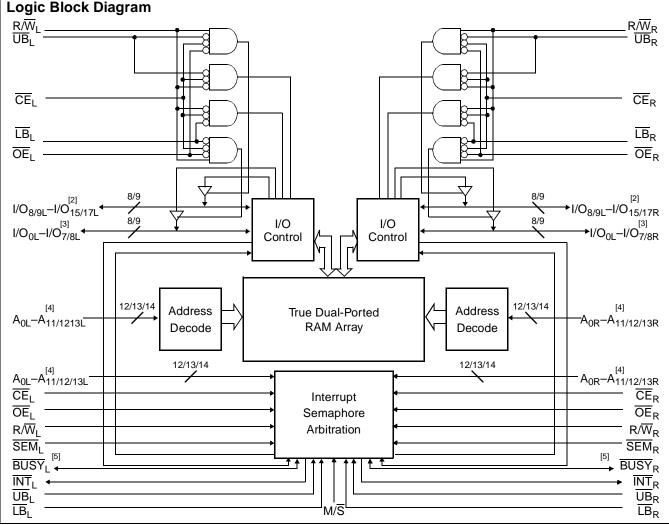
CYPRESS	PRELIMINARY	CY7C024V/025V/026V CY7C0241V/0251V/036V
	/8K/16K x 16/1	8 Dual-Port Static RAM

Features

- True dual-ported memory cells which allow simultaneous access of the same memory location
- 4/8/16K x 16 organization (CY7C024V/025V/026V)
- 4/8K x 18 organization (CY7C0241V/0251V)
- 16K x 18 organization (CY7C036V)
- 0.35-micron CMOS for optimum speed/power
- High-speed access: 15^[1]/20/25 ns
- Low operating power
 - Active: I_{CC} = 115 mA (typical)
 - Standby: I_{SB3} = 10 μA (typical)
- · Fully asynchronous operation

- Automatic power-down · Expandable data bus to 32/36 bits or more using Mas
 - ter/Slave chip select when using more than one device On-chip arbitration logic
 - · Semaphores included to permit software handshaking between ports
 - INT flag for port-to-port communication
 - · Separate upper-byte and lower-byte control
 - · Pin select for Master or Slave
 - Commercial and industrial temperature ranges
 - Available in 100-pin TQFP
 - Pin-compatible and functionally equivalent to IDT70V24, 70V25, and 7V0261.



Notes:

- 1. 2.
- 3.
- 4.
- Call for availability. $\begin{aligned} &|/O_8-I/O_{15} \text{ for x16 devices; } I/O_9-I/O_{17} \text{ for x18 devices.} \\ &|/O_0-I/O_7 \text{ for x16 devices; } I/O_0-I/O_8 \text{ for x18 devices.} \\ &\underline{A_0-A_{11}} \text{ for 4K devices; } A_0-A_{12} \text{ for 8K devices; } A_0-A_{13} \text{ for 16K devices.} \\ &\overline{\text{BUSY}} \text{ is an output in master mode and an input in slave mode.} \end{aligned}$ 5.

For the most recent information, visit the Cypress web site at www.cypress.com



Functional Description

Pin Configurations

The CY7C024V/025V/026V and CY7C0241V/0251V/036V are low-power CMOS 4K, 8K, and 16K x16/18 dual-port static RAMs. Various arbitration schemes are included on the devices to handle situations when multiple processors access the same piece of data. Two ports are provided, permitting independent, asynchronous access for reads and writes to any location in memory. The devices can be utilized as standalone 16/18-bit dual-port static RAMs or multiple devices can be combined in order to function as a 32/36-bit or wider master/slave dual-port static RAM. An M/S pin is provided for implementing 32/36-bit or wider memory applications without the need for separate master and slave devices or additional discrete logic. Application areas include interprocessor/multiprocessor designs, communications status buffering, and dual-port video/graphics memory.

Each port has independent control pins: chip enable (\overline{CE}), read or write enable ($\overline{R/W}$), and output enable (\overline{OE}). Two flags are provided on each port (BUSY and INT). BUSY signals that the port is trying to access the same location currently being accessed by the other port. The interrupt flag (INT) permits communication between ports or systems by means of a mail box. The semaphores are used to pass a flag, or token, from one port to the other to indicate that a shared resource is in use. The semaphore logic is comprised of eight shared latches. Only one side can control the latch (semaphore) at any time. Control of a semaphore indicates that a shared resource is in use. An automatic power-down feature is controlled independently on each port by a chip select (\overline{CE}) pin.

The CY7C024V/025V/026V and CY7C0241V/0251V/036V are available in 100-pin Thin Quad Plastic Flatpacks (TQFP).

100-Pin TQFP **Top View** I/01L I/00L I/00L OEL Vcc SEM SEM UBL UBL UBL NC[6] NC[6] I/O₂L GND 041 Q3I õ 100 99 98 97 96 95 94 93 92 91 90 89 88 87 86 85 84 83 82 81 80 79 78 77 76 75 NC NC NC 74 NC 2 73 NC NC NC 3 72 NC 71 A5L I/O_{10L} 5 70 A_{4L} I/O_{11L} 6 69 A_{3L} I/O_{12L} 68 A_{2L} I/O₁₃₁ 8 67 A_{1L} GND 66 I/O_{14L} 10 65 I/O_{15L} BUSY 11 64 CY7C024V (4K x 16) Vcc 12 GND 63 13 GND 62 M/SBUSYR CY7C025V (8K x 16) I/O_{0R} 14 61 I/O_{1R} 15 **INT**_R 60 I/O_{2R} 16 59 AOR Vcc 17 58 A_{1R} I/O_{3R} 18 57 A_{2R} I/O_{4R} 19 56 A_{3R} 20 I/O5r 55 A_{4R} I/O_{6R} 21 NC 54 NC 22 53 NC 23 NC NC 52 NC 24 NC 51 NC 25 26 27 28 29 30 31 32 33 34 35 36 37 38 39 40 41 42 43 44 45 46 47 48 49 50

Notes:

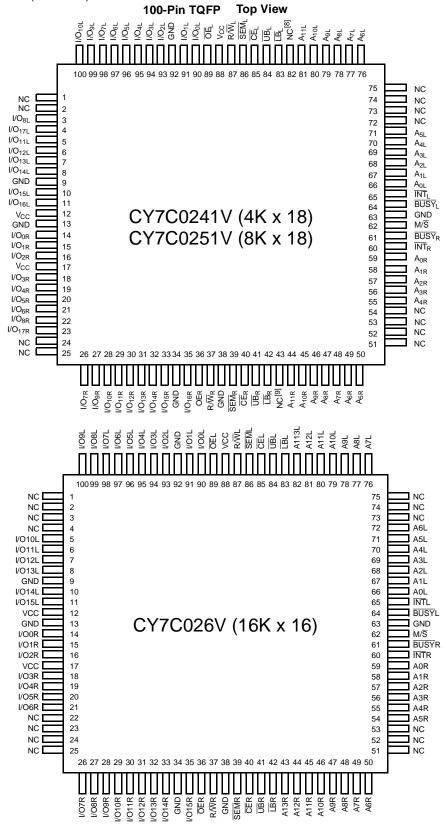
6. A_{12L} on the CY7C025.

7. A_{12R} on the CY7C025.



PRELIMINARY

Pin Configurations (continued)



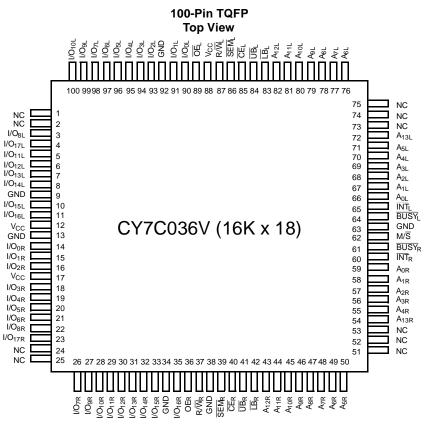
Notes:

8. A_{12L} on the CY7C0251. 9. A_{12R} on the CY7C0251.





Pin Configurations (continued)



Selection Guide

	CY7C024V/025V/026V CY7C0241V/0251V/036V -15 ^[1]	CY7C024V/025V/026V CY7C0241V/0251V/036V -20	CY7C024V/025V/026V CY7C0241V/0251V/036V -25
Maximum Access Time (ns)	15	20	25
Typical Operating Current (mA)	125	120	115
Typical Standby Current for I _{SB1} (mA) (Both ports TTL level)	35	35	30
Typical Standby Current for I _{SB3} (μA) (Both ports CMOS Level)	10 µA	10 µA	10 µA

Shaded areas contain advance information.





Pin Definitions

Left Port	Right Port	Description
CEL	CER	Chip Enable
R/WL	R/WR	Read/Write Enable
OEL	OE _R	Output Enable
A _{0L} -A _{13L}	A _{0R} -A _{13R}	Address (A_0 - A_{11} for 4K devices; A_0 - A_{12} for 8K devices; A_0 - A_{13} for 16K)
I/O _{0L} -I/O _{17L}	I/O _{0R} -I/O _{17R}	Data Bus Input/Output
SEML	SEM _R	Semaphore Enable
UBL	UB _R	Upper Byte Select (I/O ₈ –I/O ₁₅ for x16 devices; I/O ₉ –I/O ₁₇ for x18 devices)
LBL	LBR	Lower Byte Select (I/O_0 – I/O_7 for x16 devices; I/O_0 – I/O_8 for x18 devices)
INTL	INT _R	Interrupt Flag
BUSYL	BUSYR	Busy Flag
M/S		Master or Slave Select
V _{CC}		Power
GND		Ground
NC		No Connect

Maximum Ratings

(Above which the useful life may be impaired. For user guide-lines, not tested.)
Storage Temperature65°C to +150°C
Ambient Temperature with Power Applied55°C to +125°C
Supply Voltage to Ground Potential0.5V to +4.6V
DC Voltage Applied to Outputs in High Z State0.5V to V_{CC} +0.5V DC Input Voltage ^[10] 0.5V to V_{CC} +0.5V

Output Current into Outputs (LOW)	20 mA
Static Discharge Voltage	>2001V
Latch-Up Current	>200 mA

Operating Range

Range	Ambient Temperature	V _{cc}		
Commercial	0°C to +70°C	$3.3V\pm300~mV$		
Industrial	–40°C to +85°C	$3.3V\pm300~mV$		

Shaded areas contain advance information.

Note:

10. Pulse width < 20 ns.



Electrical Characteristics Over the Operating Range

		CY7C024V/025V/026V CY7C0241V/0251V/036V										
				- 15 ^[1]		-20			-25			
Parameter	Description		Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Unit
V _{OH}	Output HIGH Voltage (V _{CC} =3.3V)		2.4			2.4			2.4			V
V _{OL}	Output LOW Voltage				0.4			0.4			0.4	V
V _{IH}	Input HIGH Voltage		2.0			2.0			2.0			V
V _{IL}	Input LOW Voltage				0.8			0.8			0.8	V
I _{OZ}	Output Leakage Current		-10		10	-10		10	-10		10	μA
I _{IX}	Input Leakage Current		-10		10	-10		10	-10		10	μA
I _{CC}	Operating Current (V _{CC} = Max.,	Com'l.		125	185		120	175		115	165	mA
	I _{OUT} = 0 mA) Outputs Disabled	Indust.			•		140	195		135	185	mA
I _{SB1}	Standby Current (Both Ports TTL	Com'l.		35	50		35	45		30	40	mA
	Level) $\overline{CE}_{L} \& \overline{CE}_{R} \ge V_{IH}$, f = f _{MAX}	Indust.					45	55		40	50	mA
I _{SB2}	Standb <u>y Curren</u> t (One Port TTL	Com'l.		80	120		75	110		65	95	mA
	Level) $\overline{CE}_{L} \mid \overline{CE}_{R} \ge V_{IH}$, f = f _{MAX}	Indust.					85	120		75	105	mA
I _{SB3}	Standby Current (Both Ports CMOS	Com'l.		10	250		10	250		10	250	μA
	Level) $\overline{CE}_L \& \overline{CE}_R \ge V_{CC} - 0.2V, f = 0$	Indust.				1	10	250		10	250	μA
I _{SB4}	Standby Current (One Port CMOS Level) $\overline{CE}_L \mid \overline{CE}_R \ge V_{IH}$, f = $f_{MAX}^{[11]}$	Com'l.		75	105	1	70	95		60	80	mA
	Level) $CE_L CE_R \ge V_{IH}$, $f = f_{MAX}^{[11]}$	Indust.					80	105		70	90	mA

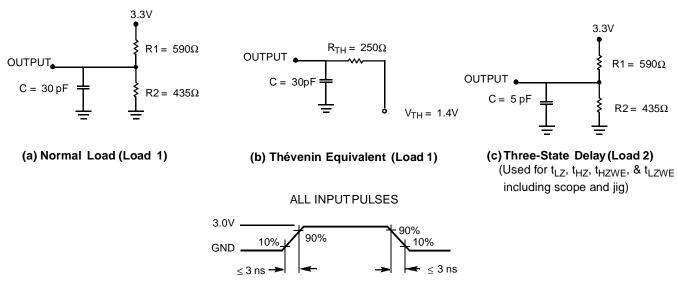
PRELIMINARY

Shaded areas contain advance information.

Capacitance^[12]

Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	$T_A = 25^{\circ}C, f = 1 \text{ MHz},$	10	pF
C _{OUT}	Output Capacitance	$V_{CC} = 3.3V$	10	pF

AC Test Loads and Waveforms



- 11. $f_{MAX} = 1/t_{RC} = All$ inputs cycling at $f = 1/t_{RC}$ (except output enable). f = 0 means no address or control lines change. This applies only to inputs at CMOS level standby I_{SB3} . 12. Tested initially and after any design or process changes that may affect these parameters.



PRELIMINARY

Switching Characteristics Over the Operating Range^[13]

			CY7C024V/025V/026V CY7C0241V/0251V/036V						
		-1	5 ^[1]	-20		-2	25		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Unit	
READ CYCLE		•							
t _{RC}	Read Cycle Time	15		20		25		ns	
t _{AA}	Address to Data Valid		15		20		25	ns	
t _{OHA}	Output Hold From Address Change	3		3		3		ns	
t _{ACE} ^[14]	CE LOW to Data Valid		15		20		25	ns	
toor	OE LOW to Data Valid		10		12		13	ns	
t _{LZOE} [15, 16, 17]	OE Low to Low Z	3		3		3		ns	
t _{HZOE} [15, 16, 17]	OE HIGH to High Z		10		12		15	ns	
t _{LZCE} [15, 16, 17]	CE LOW to Low Z	3		3		3		ns	
t _{HZCE} [15, 16, 17]	CE HIGH to High Z		10		12		15	ns	
t _{PU} ^[17]	CE LOW to Power-Up	0		0		0		ns	
t _{PD} ^[17]	CE HIGH to Power-Down		15		20		25	ns	
t _{ABE} ^[14]	Byte Enable Access Time		15		20		25	ns	
WRITE CYCL	Ē								
t _{WC}	Write Cycle Time	15		20		25		ns	
t _{SCE} ^[14]	CE LOW to Write End	12		15		20		ns	
t _{AW}	Address Valid to Write End	12		15		20		ns	
t _{HA}	Address Hold From Write End	0		0		0		ns	
t _{SA} ^[14]	Address Set-Up to Write Start	0		0		0		ns	
t _{PWE}	Write Pulse Width	12		15		20		ns	
t _{SD}	Data Set-Up to Write End	10		15		15		ns	
t _{HD}	Data Hold From Write End	0		0		0		ns	
t _{HZWE} [16, 17]	R/\overline{W} LOW to High Z		10		12		15	ns	
t _{LZWE} [16, 17]	R/W HIGH to Low Z	3		3		0		ns	
t _{WDD} ^[18]	Write Pulse to Data Delay		30		45		50	ns	
t _{DDD} ^[18]	Write Data Valid to Read Data Valid		25		30		35	ns	
			1	1	1	1	1		

Notes:

13. Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified I_{O}/I_{OH} and 30-pF load capacitance. 14. To access RAM, \overline{CE} =L, \overline{UB} =L, \overline{SEM} =H. To access semaphore, \overline{CE} =H and \overline{SEM} =L. Either condition must be valid for the entire t_{SCE} time.

15. At any given temperature and voltage condition for any given device, t_{HZCE} is less than t_{LZCE} and t_{HZOE} is less than t_{LZOE} .

Test conditions used are Load 3. 16.

This parameter is guaranteed but not tested. For information on port-to-port delay through RAM cells from writing port to reading port, refer to Read Timing 17. with Busy waveform. 18. For information on port-to-port delay through RAM cells from writing port to reading port, refer to Read Timing with Busy waveform.



PRELIMINARY

Switching Characteristics Over the Operating Range^[13] (continued)

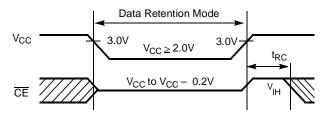
		CY7C024V/025V/026V CY7C0241V/0251V/036V						
		-15 ^[1]		-20		-25		1
Parameter	r Description	Min.	Max.	Min.	Max.	Min.	Max.	Unit
BUSY TIMI	NG ^[19]					•	<u>.</u>	
t _{BLA}	BUSY LOW from Address Match		15		20		20	ns
t _{BHA}	BUSY HIGH from Address Mismatch		15		20		20	ns
t _{BLC}	BUSY LOW from CE LOW		15		20		20	ns
t _{BHC}	BUSY HIGH from CE HIGH		15		17		17	ns
t _{PS}	Port Set-Up for Priority	5		5		5		ns
t _{WB}	R/W HIGH after BUSY (Slave)	0		0		0		ns
t _{WH}	R/W HIGH after BUSY HIGH (Slave)	13		15		17		ns
t _{BDD} ^[20]	BUSY HIGH to Data Valid		15		20		25	ns
INTERRUP	T TIMING ^[19]	•				•	·	4
t _{INS}	INT Set Time		15		20		20	ns
t _{INR}	INT Reset Time		15		20		20	ns
SEMAPHO	RE TIMING	•				•	·	4
t _{SOP}	SEM Flag Update Pulse (OE or SEM)	10		10		12		ns
t _{SWRD}	SEM Flag Write to Read Time	5		5		5		ns
t _{SPS}	SEM Flag Contention Window	5		5		5		ns
t _{SAA}	SEM Address Access Time		15		20		25	ns

Data Retention Mode

The CY7C024V/025V/026V and CY7C0241V/0251V/036V are designed with battery backup in mind. Data retention voltage and supply current are guaranteed over temperature. The following rules ensure data retention:

- 1. Chip Enable (CE) must be held HIGH during data retention, within V_{CC} to V_{CC} – 0.2V.
- 2. $\overline{\text{CE}}$ must be kept between V_{CC} 0.2V and 70% of V_{CC} during the power-up and power-down transitions.
- 3. The RAM can begin operation $>t_{RC}$ after V_{CC} reaches the minimum operating voltage (3.0 volts).

Timing



Parameter	Test Conditions ^[21]	Max.	Unit	
ICC _{DR1}	@ VCC _{DR} = 2V	50	μΑ	

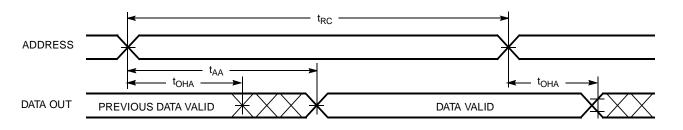
- Test conditions used are Load 2.
 t_{BDD} is a calculated parameter and is the greater of t_{WDD}-t_{PWE} (actual) or t_{DDD}-t_{SD} (actual).
 CE = V_{CC}, V_{in} = GND to V_{CC}, T_A = 25°C. This parameter is guaranteed but not tested.



CY7C024V/025V/026V CY7C0241V/0251V/036V

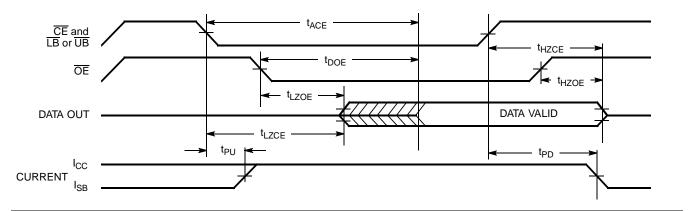
Switching Waveforms

Read Cycle No.1 (Either Port Address Access)^[22, 23, 24]

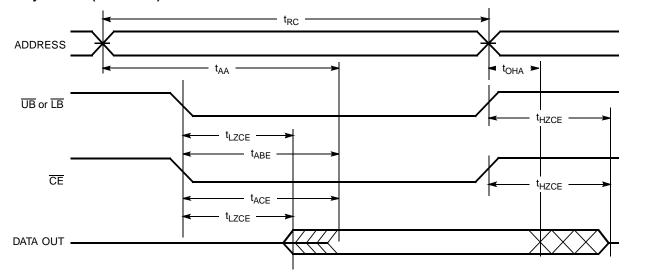


PRELIMINARY

Read Cycle No.2 (Either Port CE/OE Access)^[22, 25, 26]



Read Cycle No. 3 (Either Port)^[22, 24, 25, 26]



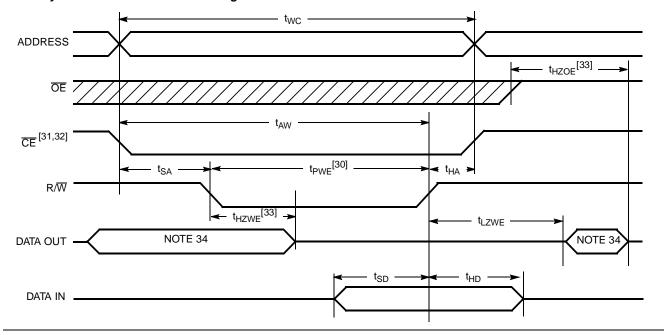
Notes:

22. R/\overline{W} is HIGH for read cycles. 23. Device is continuously selected $\overline{CE} = V_{IL}$ and \overline{UB} or $\overline{LB} = V_{IL}$. This waveform cannot be used for semaphore reads.

- 23. Device is continuously solution of V_{IL} and V_{IL} . 24. $\overline{OE} = V_{IL}$. 25. Address valid prior to or coincident with \overline{CE} transition LOW. 26. To access RAM, $\overline{CE} = V_{IL}$, \overline{UB} or $\overline{LB} = V_{IL}$, $\overline{SEM} = V_{IH}$. To access semaphore, $\overline{CE} = V_{IH}$, $\overline{SEM} = V_{IL}$.

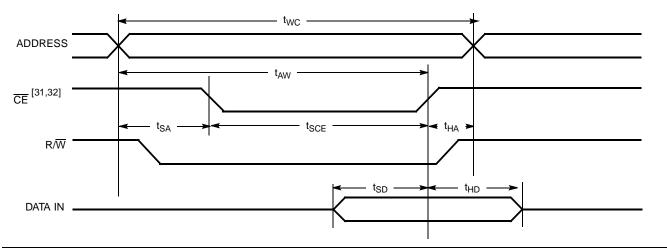


Write Cycle No.1: R/W Controlled Timing^[27, 28, 29, 30]



PRELIMINARY

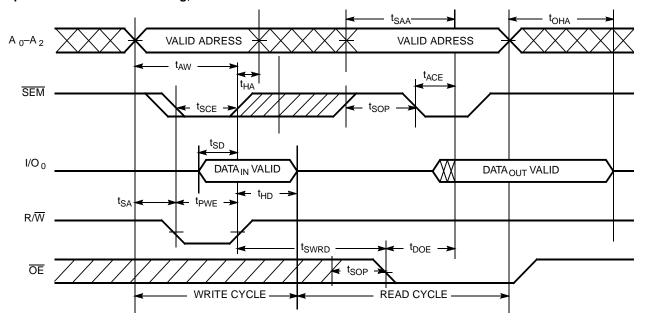
Write Cycle No. 2: **CE** Controlled Timing^[27, 28, 29, 35]



- Notes:
 27. RŴ must be HIGH during all address transitions.
 28. A write occurs during the overlap (t_{SCE} or t_{PWE}) of a LOW CE or SEM and a LOW UB or LB.
 29. t_{HA} is measured from the earlier of CE or RŴ or (SEM or RŴ) going HIGH at the end of write cycle.
 30. If OE is LOW during a RŴ controlled write cycle, the write pulse width must be the larger of t_{PWE} or (t_{HZWE} + t_{SD}) to allow the I/O drivers to turn off and data to be placed on the bus for the required t_{SD}. If OE is HIGH during an RŴ controlled write cycle, this requirement does not apply and the write pulse can be as short as the specified t_{PWE}.
 31. To access RAM, CE = V_{IL}, SEM = V_{IH}.
 32. To access lower byte, CE = V_{IL}, UB = V_{IL}, SEM = V_{IH}.
 33. Transition is measured ±500 mV from steady state with a 5-pF load (including scope and jig). This parameter is sampled and not 100% tested.
 34. During this period, the I/O pins are in the output state, and input signals must not be applied.
 35. If the CE or SEM LOW transition occurs simultaneously with or after the RW LOW transition, the outputs remain in the high-impedance state.

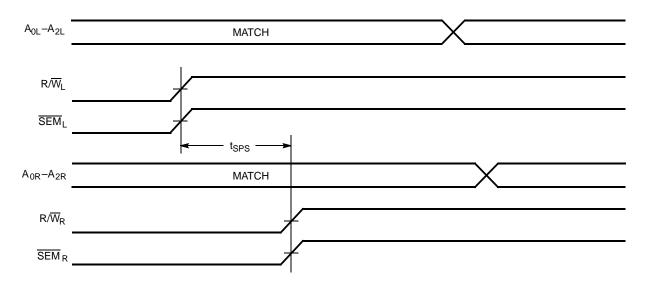


Semaphore Read After Write Timing, Either Side^[36]



PRELIMINARY

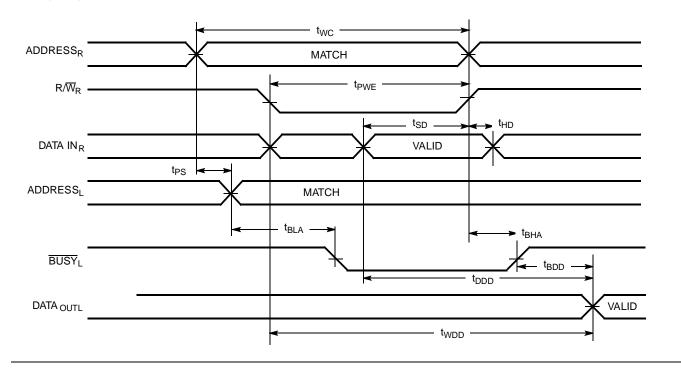
Timing Diagram of Semaphore Contention^[37, 38, 39]



- 36. \overline{CE} = HIGH for the duration of the above timing (both write and read cycle). 37. $I/O_{OR} = I/O_{OL} = LOW$ (request semaphore); $\overline{CE}_R = \overline{CE}_L = HIGH$. 38. Semaphores are reset (available to both ports) at cycle start. 39. If t_{SPS} is violated, the semaphore will definitely be obtained by one side or the other, but which side will get the semaphore is unpredictable.

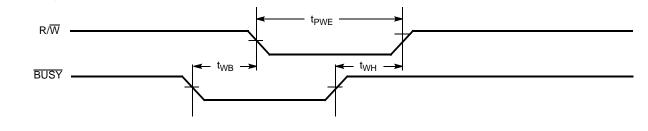


Timing Diagram of Read with $\overline{\text{BUSY}}$ (M/ $\overline{\text{S}}$ =HIGH)^[40]



PRELIMINARY

Write Timing with Busy Input (M/S=LOW)



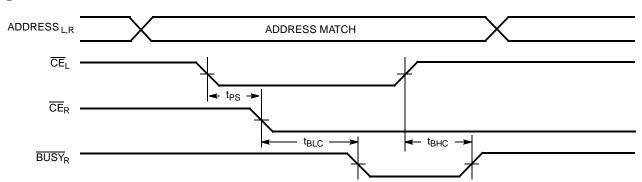
Note:

40. $\overline{CE}_{L} = \overline{CE}_{R} = LOW.$



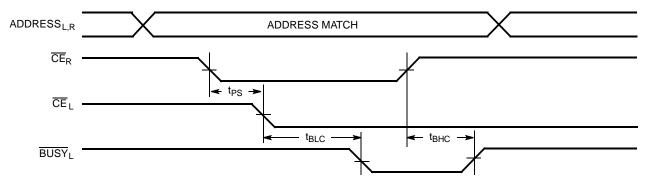
Busy Timing Diagram No.1 (CE Arbitration)^[41]

CE_LValid First:

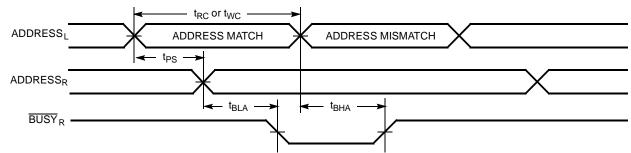


PRELIMINARY

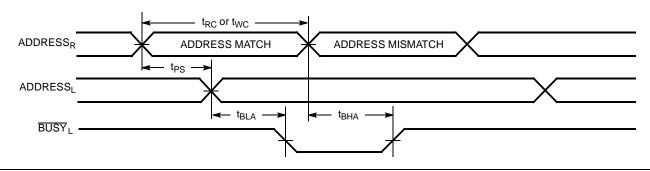
CE_R Valid First:



Busy Timing Diagram No.2 (Address Arbitration)^[41] Left Address Valid First:



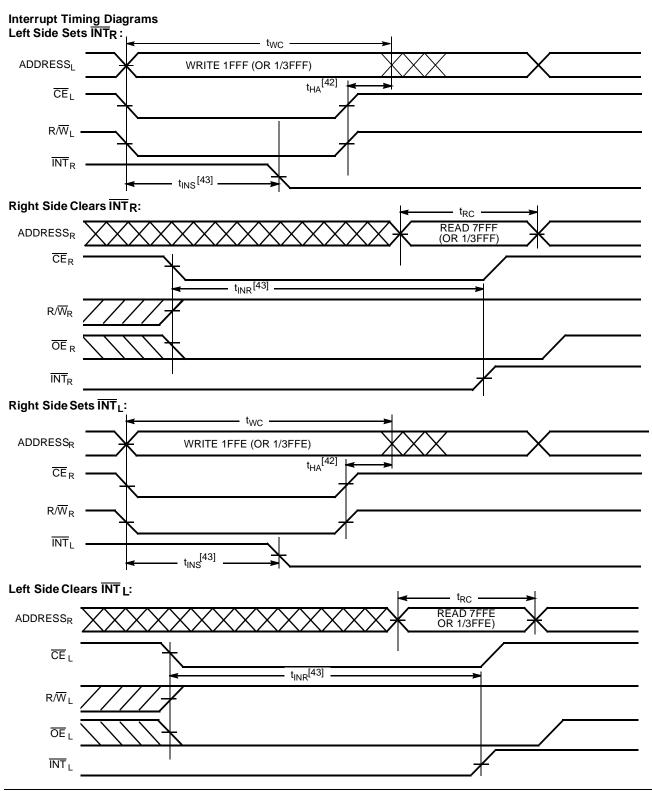
Right Address Valid First:



Note:

41. If t_{PS} is violated, the busy signal will be asserted on one side or the other, but there is no guarantee to which side BUSY will be asserted.





PRELIMINARY

Notes:

43. t_{INS} or t_{INR} depends on which enable pin (\overline{CE}_L or $R\overline{W}_L$) is asserted last.

^{42.} t_{HA} depends on which enable pin (\overline{CE}_L or \underline{RW}_L) is deasserted first.



Architecture

The CY7C024V/025V/026V and CY7C0241V/0251V/036V consist of an array of 4K, 8K, and 16K words of 16 and 18 bits each of dual-port RAM cells, I/O and address lines, and control signals (CE, OE, R/W). These control pins permit independent access for reads or writes to any location in memory. To handle simultaneous writes/reads to the same location, a BUSY pin is provided on each port. Two Interrupt (INT) pins can be utilized for port-to-port communication. Two semaphore (SEM) control pins are used for allocating shared resources. With the M/S pin, the devices can function as a master (BUSY pins are outputs) or as a slave (BUSY pins are inputs). The devices also have an automatic power-down feature controlled by CE. Each port is provided with its own output enable control (OE), which allows data to be read from the device.

Functional Description

Write Operation

Data must be set up for a duration of t_{SD} before the rising edge of R/W in order to guarantee a valid write. A write operation is controlled by either the R/W pin (see Write Cycle No. 1 waveform) or the CE pin (see Write Cycle No. 2 waveform). Required inputs for non-contention operations are summarized in *Table 1*.

If a location is being written to by one port and the opposite port attempts to read that location, a port-to-port flowthrough delay must occur before the data is read on the output; otherwise the data read is not deterministic. Data will be valid on the port t_{DDD} after the data is presented on the other port.

Read Operation

When reading the device, the user must assert both the \overline{OE} and \overline{CE} pins. Data will be available t_{ACE} after \overline{CE} or t_{DOE} after \overline{OE} is asserted. If the user wishes to access a semaphore flag, then the \overline{SEM} pin must be asserted instead of the \overline{CE} pin, and \overline{OE} must also be asserted.

Interrupts

The upper two memory locations may be used for message passing. The highest memory location (FFF for the CY7C024V/41V, 1FFF for the CY7C025V/51V, 3FFF for the CY7C026V/36V) is the mailbox for the right port and the second-highest memory location (FFE for the CY7C024V/41V, 1FFE for the CY7C025V/51V, 3FFE for the CY7C026V/36V) is the mailbox for the left port. When one port writes to the other port's mailbox, an interrupt is generated to the owner. The interrupt is reset when the owner reads the contents of the mailbox. The message is user defined.

Each port can read the other port's mailbox without resetting the interrupt. The active state of the busy signal (to a port) prevents the port from setting the interrupt to the winning port. Also, an active busy to a port prevents that port from reading its own mailbox and, thus, resetting the interrupt to it.

If an application does not require message passing, do not connect the interrupt pin to the processor's interrupt request input pin.

The operation of the interrupts and their interaction with Busy are summarized in *Table 2*.

Busy

The CY7C024V/025V/026V and CY7C0241V/0251V/036V provide on-chip arbitration to resolve simultaneous memory location access (contention). If both ports' CEs are asserted

and an address match occurs within t_{PS} of each other, the busy logic will determine which port has access. If t_{PS} is violated, one port will definitely gain permission to the location, but it is not predictable which port will get that permission. BUSY will be asserted t_{BLA} after an address match or t_{BLC} after \overline{CE} is taken LOW.

Master/Slave

A M/S pin is provided in order to expand the word width by configuring the device as either a master or a slave. The BUSY output of the master is connected to the BUSY input of the slave. This will allow the device to interface to a master device with no external components. Writing to slave devices must be delayed until after the BUSY input has settled (t_{BLC} or t_{BLA}), otherwise, the slave chip may begin a write cycle during a contention situation. When tied HIGH, the M/S pin allows the device to be used as a master and, therefore, the BUSY line is an output. BUSY can then be used to send the arbitration outcome to a slave.

Semaphore Operation

The CY7C024V/025V/026V and CY7C0241V/0251V/036V provide eight semaphore latches, which are separate from the dual-port memory locations. Semaphores are used to reserve resources that are shared between the two ports. The state of the semaphore indicates that a resource is in use. For example, if the left port wants to request a given resource, it sets a latch by writing a zero to a semaphore location. The left port then verifies its success in setting the latch by reading it. After writing to the semaphore, SEM or OE must be deasserted for t_{SOP} before attempting to read the semaphore. The semaphore value will be available t_{SWRD} + t_{DOE} after the rising edge of the semaphore write. If the left port was successful (reads a zero), it assumes control of the shared resource, otherwise (reads a one) it assumes the right port has control and continues to poll the semaphore. When the right side has relinquished control of the semaphore (by writing a one), the left side will succeed in gaining control of the semaphore. If the left side no longer requires the semaphore, a one is written to cancel its request.

Semaphores are accessed by asserting \overline{SEM} LOW. The \overline{SEM} pin functions as a chip select for the semaphore latches (\overline{CE} must remain HIGH during \overline{SEM} LOW). A₀₋₂ represents the semaphore address. \overline{OE} and R/W are used in the same manner as a normal memory access. When writing or reading a semaphore, the other address pins have no effect.

When writing to the semaphore, only I/O_0 is used. If a zero is written to the left port of an available semaphore, a one will appear at the same semaphore address on the right port. That semaphore can now only be modified by the side showing zero (the left port in this case). If the left port now relinquishes control by writing a one to the semaphore, the semaphore will be set to one for both sides. However, if the right port had requested the semaphore (written a zero) while the left port had control, the right port would immediately own the semaphore as soon as the left port released it. *Table 3* shows sample semaphore operations.

When reading a semaphore, all sixteen/eighteen data lines output the semaphore value. The read value is latched in an output register to prevent the semaphore from changing state during a write from the other port. If both ports attempt to access the semaphore within t_{SPS} of each other, the semaphore will definitely be obtained by one side or the other, but there is no guarantee which side will control the semaphore.



Table 1. Non-Contending Read/Write

		In	puts			Οι	utputs	
CE	R/W	OE	UB	LB	SEM	I/O ₉ -I/O ₁₇	I/O ₀ –I/O ₈	Operation
Н	Х	Х	Х	Х	Н	High Z	High Z	Deselected: Power-Down
Х	Х	Х	Н	Н	Н	High Z	High Z	Deselected: Power-Down
L	L	Х	L	Н	Н	Data In	High Z	Write to Upper Byte Only
L	L	Х	Н	L	Н	High Z	Data In	Write to Lower Byte Only
L	L	Х	L	L	Н	Data In	Data In	Write to Both Bytes
L	Н	L	L	Н	Н	Data Out	High Z	Read Upper Byte Only
L	Н	L	Н	L	Н	High Z	Data Out	Read Lower Byte Only
L	Н	L	L	L	Н	Data Out	Data Out	Read Both Bytes
Х	Х	Н	Х	Х	Х	High Z	High Z	Outputs Disabled
Н	Н	L	Х	Х	L	Data Out	Data Out	Read Data in Semaphore Flag
Х	Н	L	Н	Н	L	Data Out	Data Out	Read Data in Semaphore Flag
Н		Х	Х	Х	L	Data In	Data In	Write D _{IN0} into Semaphore Flag
Х		Х	Н	Н	L	Data In	Data In	Write D _{IN0} into Semaphore Flag
L	Х	Х	L	Х	L			Not Allowed
L	Х	Х	Х	L	L			Not Allowed

Table 2. Interrupt Operation Example (assumes **BUSY**_L=**BUSY**_R=HIGH)^[44]

	Left Port				Right Port					
Function	R/₩ _L		OEL	A _{0L-13L}	\overline{INT}_{L}	R/W _R	CER	OER	A _{0R-13R}	INT _R
Set Right INT _R Flag	L	L	Х	FFF ^[47]	Х	Х	Х	Х	Х	L ^[46]
Reset Right INT _R Flag	Х	Х	Х	Х	Х	Х	L	L	FFF (or 1/3FFF)	H ^[45]
Set Left INT _L Flag	Х	Х	Х	Х	L ^[45]	L	L	Х	1FFE (or 1/3FFE)	Х
Reset Left INT _L Flag	Х	L	L	1FFE ^[47]	H ^[46]	Х	Х	Х	Х	Х

Table 3. Semaphore Operation Example

Function	I/O ₀ -I/O ₁₇ Left	I/O ₀ -I/O ₁₇ Right	Status
No action	1	1	Semaphore free
Left port writes 0 to semaphore	0	1	Left Port has semaphore token
Right port writes 0 to semaphore	0	1	No change. Right side has no write access to semaphore
Left port writes 1 to semaphore	1	0	Right port obtains semaphore token
Left port writes 0 to semaphore	1	0	No change. Left port has no write access to semaphore
Right port writes 1 to semaphore	0	1	Left port obtains semaphore token
Left port writes 1 to semaphore	1	1	Semaphore free
Right port writes 0 to semaphore	1	0	Right port has semaphore token
Right port writes 1 to semaphore	1	1	Semaphore free
Left port writes 0 to semaphore	0	1	Left port has semaphore token
Left port writes 1 to semaphore	1	1	Semaphore free

Notes:

44. See Functional Description for specific highest memory locations by device.
45. If BUSY_R=L, then no change.
46. If BUSY_L=L, then no change.
47. See Functional Description for specific addresses by device.



Ordering Information

4K x16 3.3V Asynchronous Dual-Port SRAM

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
15 ^[1]	CY7C024V-15AC	A100	100-Pin Thin Quad Flat Pack	Commercial
20	CY7C024V-20AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C024V-20AI	A100	100-Pin Thin Quad Flat Pack	Industrial
25	CY7C024V-25AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C024V-25AI	A100	100-Pin Thin Quad Flat Pack	Industrial

PRELIMINARY

8K x16 3.3V Asynchronous Dual-Port SRAM

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
15 ^[1]	CY7C025V-15AC	A100	100-Pin Thin Quad Flat Pack	Commercial
20	CY7C025V-20AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C025V-20AI	A100	100-Pin Thin Quad Flat Pack	Industrial
25	CY7C025V-25AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C025V-25AI	A100	100-Pin Thin Quad Flat Pack	Industrial

16K x18 3.3V Asynchronous Dual-Port SRAM

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
15 ^[1]	CY7C026V-15AC	A100	100-Pin Thin Quad Flat Pack	Commercial
20	CY7C026V-20AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C026V-20AI	A100	100-Pin Thin Quad Flat Pack	Industrial
25	CY7C026V-25AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C026V-25AI	A100	100-Pin Thin Quad Flat Pack	Industrial

4K x18 3.3V Asynchronous Dual-Port SRAM

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
15 ^[1]	CY7C0241V-15AC	A100	100-Pin Thin Quad Flat Pack	Commercial
20	CY7C0241V-20AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C0241V-20AI	A100	100-Pin Thin Quad Flat Pack	Industrial
25	CY7C0241V-25AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C0241V-25AI	A100	100-Pin Thin Quad Flat Pack	Industrial

8K x18 3.3V Asynchronous Dual-Port SRAM

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
15 ^[1]	CY7C0251V-15AC	A100	100-Pin Thin Quad Flat Pack	Commercial
20	CY7C0251V-20AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C0251V-20AI	A100	100-Pin Thin Quad Flat Pack	Industrial
25	CY7C0251V-25AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C0251V-25AI	A100	100-Pin Thin Quad Flat Pack	Industrial

Shaded areas contain advance information.



Ordering Information (continued)

16K x18 3.3V Asynchronous Dual-Port SRAM

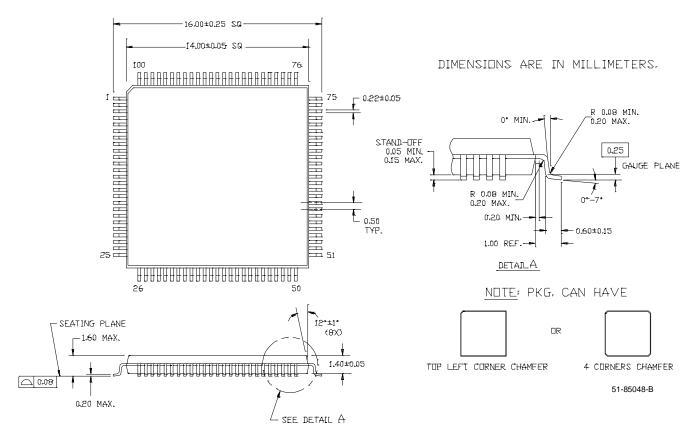
Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
15 ^[1]	CY7C036V-15AC	A100	100-Pin Thin Quad Flat Pack	Commercial
20	CY7C036V-20AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C036V-20AI	A100	100-Pin Thin Quad Flat Pack	Industrial
25	CY7C036V-25AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C036V-25AI	A100	100-Pin Thin Quad Flat Pack	Industrial

PRELIMINARY

Shaded areas contain advance information.

Document #: 38-00678-B

Package Diagram



100-Pin Thin Plastic Quad Flat Pack (TQFP) A100



CY7C036 Dual Port Design Consideration – Data Sheet Addendum

This design consideration applies to the Internal Power-On-Reset (POR) circuit used on the CY7C036 and its derivatives listed below.

Power supply ramp—The devices will function properly and meet all data sheet specifications if the power supply ramp rate is greater than 100 ns. If ramp is less than 100 ns, you may see a non-destructive failure in which the device will not respond to changes in address or clock, but the I/Os will respond to the output enable.

Applications consideration—If the power supply ramps in less than 100 ns, a small resistor $(20-50\Omega)$, a large capacitor, or an RC network can be connected at the output of the power supply to ground. The addition of a resistor will help clean up the power lines, while the capacitor will slow down the ramp rate without the loss of any power. Contact your local Cypress FAE for assistance as needed.

Troubleshooting—If a problem occurs with the part, power down the device to ground and then power up again at slower ramp rate (greater than 100 ns) in order to confirm that the problem might be due to the POR circuit. If the dual-port functions properly once the ramp rate is slowed to 100 ns or greater, then the POR circuit is at fault.

Applicable devices—All speed/package/temperature combinations of the following:

- CY7C024V
- CY7C025V
- CY7C026V
- CY7C0241V
- CY7C0251V
- CY7C036V

Cypress design change—Cypress design team has identified the root cause. A permanent circuit change and die revision will be available beginning in October and will be identified by the letter "A" in the part number.

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